



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

~~Kinsman~~ et al.

Serial No.: 09/538,684

Filed: March 30, 2000

**For: VARIED-THICKNESS HEAT SINK
FOR INTEGRATED CIRCUIT (IC)
PACKAGES AND METHOD OF
FABRICATING IC PACKAGES**

Examiner: D. Graybill

Group Art Unit: 2814

Attorney Docket No.: 3056.1US (96-803.1)

CERTIFICATE OF MAILING

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail (under 37 C.F.R. § 1.8(a)) on the date of deposit shown below with sufficient postage and in an envelope addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231.

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(37 C.F.R. § 1.34(b))

Commissioner for Patents
Washington, D.C. 20231

Sir:

In accordance with 37 C.F.R. § 1.34(b), please recognize the following individual as an associate agent/attorney herein in connection with the above-identified patent application:

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Respectfully submitted,

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